

Vishay Siliconix

COMPLIANT

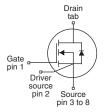
HALOGEN

**FREE** 

# **E Series Power MOSFET**

#### PowerPAK® 10 x 12





N-Channel	MOSFEI	

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.160			
Q <sub>g</sub> max. (nC)	33			
Q <sub>gs</sub> (nC)	7			
Q <sub>gd</sub> (nC)	11			
Configuration	Single			

#### **FEATURES**

- 4th generation E series technology
- Low figure-of-merit (FOM) R<sub>on</sub> x Q<sub>g</sub>
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 10 x 12
Lead (Pb)-free and halogen-free	SiHK185N60E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	$V_{DS}$	600	V			
Gate-source voltage	$V_{GS}$	± 30	V			
Continuous drain current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	- I <sub>D</sub>	19			
	$T_C = 100 ^{\circ}$ C		12	Α		
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	44				
Linear derating factor			0.9	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	75	mJ		
Maximum power dissipation		$P_D$	114	W		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 125 °C	dv/dt	100	V/ns		
Reverse diode dv/dt <sup>c</sup>		uv/ut	22	V/115		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 2.3 A
- c.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	$R_{thJA}$	-	50 <sup>a</sup>	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	1.1	G/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Cata assuma lagicara		,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Gate-source leakage	$I_{GSS}$	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava sata valtasa duain ayuwant	1	V <sub>DS</sub> =	: 600 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 9.5 A	-	0.160	0.185	Ω
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> = 9.5 A	-	5.3	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ ,		-	1085		-
Output capacitance	C <sub>oss</sub>	Τ,	$V_{DS} = 0 V_{Y}$ , $V_{DS} = 100 V_{Y}$		56	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>b</sup>	C <sub>o(er)</sub>	V 0V (00 V V 0 V		-	59	-	pF
Effective output capacitance, time related <sup>c</sup>	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0 V	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		301	-	
Total gate charge	Qg			-	22	33	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 9.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	7	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	11	-	
Turn-on delay time	t <sub>d(on)</sub>			-	14	28	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub> = 9.5 A,	-	49	98	
Turn-off delay time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		22	44	ns
Fall time	t <sub>f</sub>	7			23	46	
Gate input resistance	R <sub>g</sub>	f = 1 MHz		0.3	0.7	1.4	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol showing the		-	19	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	44	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 9.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>		$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 9.5 \text{A},$		282	564	ns
Reverse recovery charge	Q <sub>rr</sub>				3.6	7.2	μC
Reverse recovery current	I <sub>RRM</sub>	di/dt = 100 A/μs, V <sub>R</sub> = 25 V		_	24	-	A

#### Notes

- a. When mounted on 1" x 1" FR4 board
- b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 400 V
- c.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 400 V



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

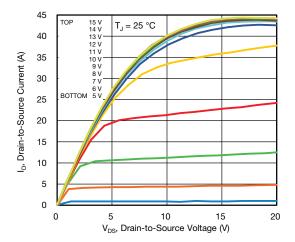


Fig. 1 - Typical Output Characteristics

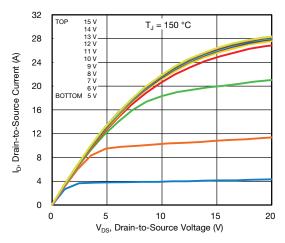


Fig. 2 - Typical Output Characteristics

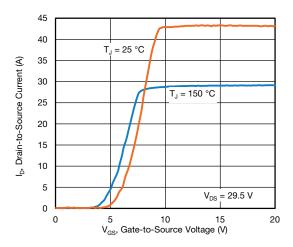


Fig. 3 - Typical Transfer Characteristics

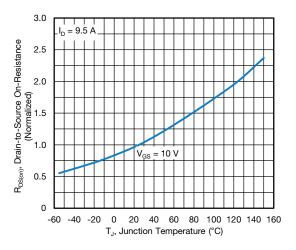


Fig. 4 - Normalized On-Resistance vs. Temperature

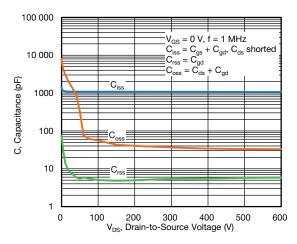


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

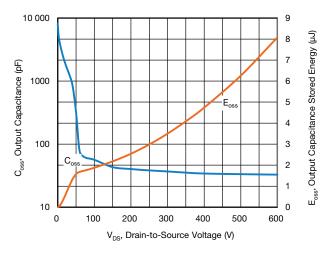


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 



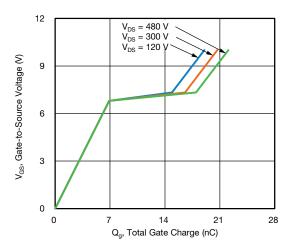


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

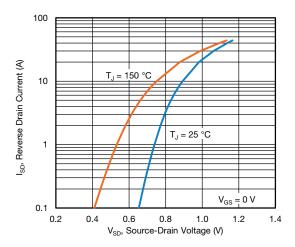


Fig. 8 - Typical Source-Drain Diode Forward Voltage

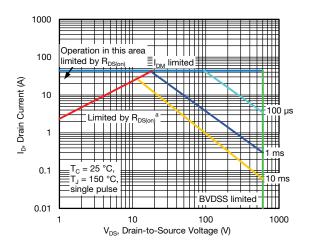


Fig. 9 - Maximum Safe Operating Area

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

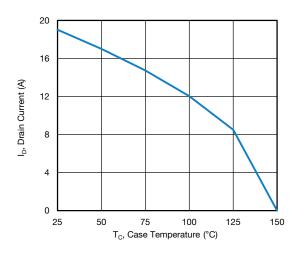


Fig. 10 - Maximum Drain Current vs. Case Temperature

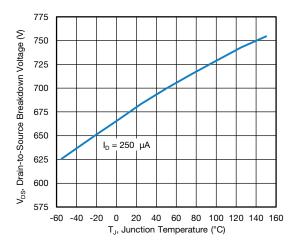


Fig. 11 - Temperature vs. Drain-to-Source Voltage



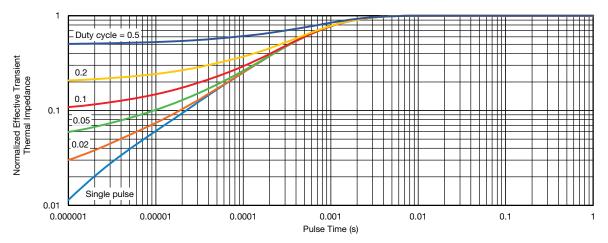


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

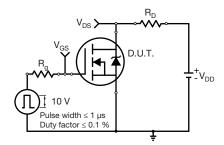


Fig. 13 - Switching Time Test Circuit

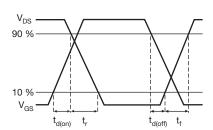


Fig. 14 - Switching Time Waveforms

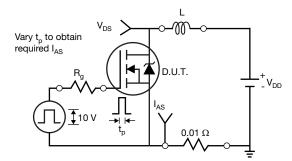


Fig. 15 - Unclamped Inductive Test Circuit

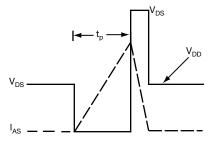


Fig. 16 - Unclamped Inductive Waveforms

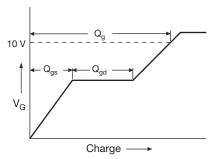


Fig. 17 - Basic Gate Charge Waveform

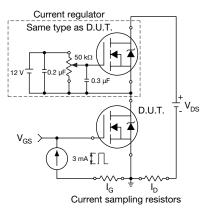
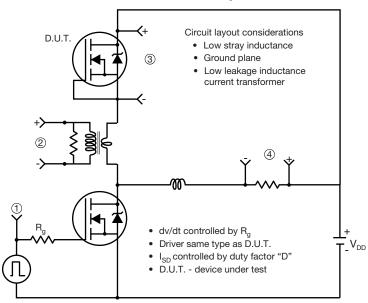


Fig. 18 - Gate Charge Test Circuit



#### Peak Diode Recovery dv/dt Test Circuit



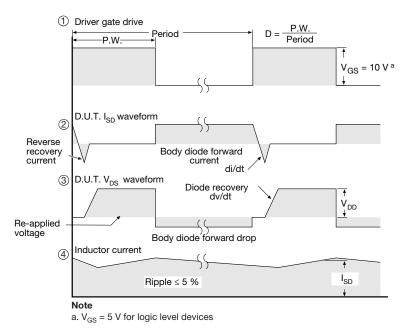
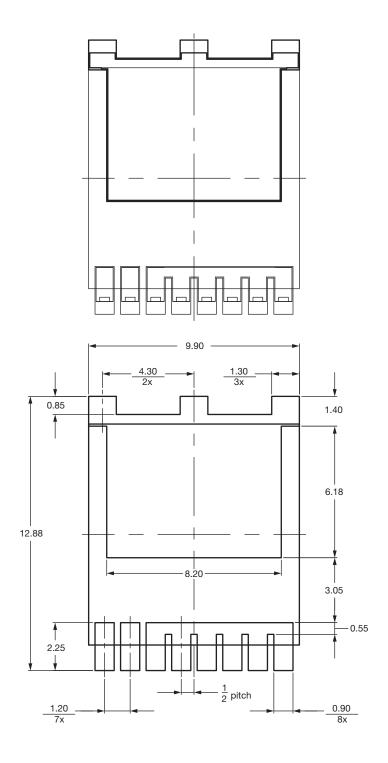


Fig. 19 - For N-Channel

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# Recommended Land Pattern PowerPAK® 10 x 12 (TOLL) (High Voltage)



#### Note

• Dimensions in mm

ECN: S22-1061-Rev. C, 26-Dec-2022

DWG: 3013



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